2023년 2월 13일(월)~ 15일(수) | 강원도 하이원리조트(그랜드호텔 컨벤션타워)

2023년 2월 14일(화), 10:55-12:25 Room L (다이아몬드 II, 6층)

G. Device & Process Modeling, Simulation and Reliability 분과 [TL2-G] TCAD Simulation and Reliability

좌장: 이재우 교수(고려대학교)

48. MMT #1(#11114#)	
TL2-G-1 10:55-11:25 [초청]	Toward Realistic Plasma Process Modeling and Simulation Jae-Hyeong Park ¹ , Won-Seok Chang ² , Hae-Sung You ¹ , Deuk-Chul Kwon ² , Jung Sik Yoon ² , and Yeon-Ho Im ¹ ¹ School of Semiconductor and Chemical Engineering, Jeonbuk National University, ² Plasma Technology Research Center, Korea Institute of Fusion Energy
TL2-G-2 11:25-11:40	FDSOI-Based Polarity Gate-Less Reconfigurable FET Dong Hyeok Lee ¹ and Jiwon Chang ² ¹ Department of Materials Science and Engineering, Yonsei University, ² Department of System Semiconductor Engineering, Yonsei University
TL2-G-3 11:40-11:55	Global Variability in 2-levels Stacked Nanowire Gate-All-Around Field Effect Transistor Donghyun Kim ^{1,2} , Sylvain Barraud ³ , Gerard Ghibaudo ¹ , Christoforos Theodorou ¹ , and Jae Woo Lee ² ¹ Université Grenoble Alpes, Université Savoie Mont Blanc, Grenoble INP, CNRS, IMEP-LAHC, ² Department of Electronics and Information Engineering, Korea University, ³ Université Grenoble Alpes, CEA, LETI
TL2-G-4 11:55-12:10	Mechanism of Gate Oxide Breakdown for Highly Doped Carbon Transistor NJ. Kim, GJ. Kim, S. Lee, NH. Lee, YC. Hwang, and HS. Kim Memory Division, Samsung Electronics Co., Ltd.
TL2-G-5 12:10-12:25	Frequency-Dependent Kink Effect in Floating Body PD-SOI MOSFETs Kyeongjun Kim and Seonghearn Lee Department of Electronics Engineering, Hankuk University of Foreign Studies